

Printing Beyond Color



Digital Fabrication



Porto / P, March 04, 2013

a new manufacturing concept



Reinhard R. Baumann

Chemnitz University of Technology
Chair of Digital Printing

Fraunhofer Institute for Electronic Nano Systems Chemnitz
Business Unit Green and Wireless
Dpt. Printed Functionalities

Chemnitz Smart Systems Campus → the Printed Electronics Partners



Printing Beyond

- The Manufacturing Technology Printing
- Functional Printing Machinery
- Applications: Printed Smart Objects

Printing is a general manufacturing technology

Printing is an additive technology

- ink is deposited on the substrate only at positions where its functionality is essential
- no material removal, no lithography is needed
- valid for digital printing, batch size ≥ 1 , setup time ≥ 0

Printing is a continuous manufacturing technology

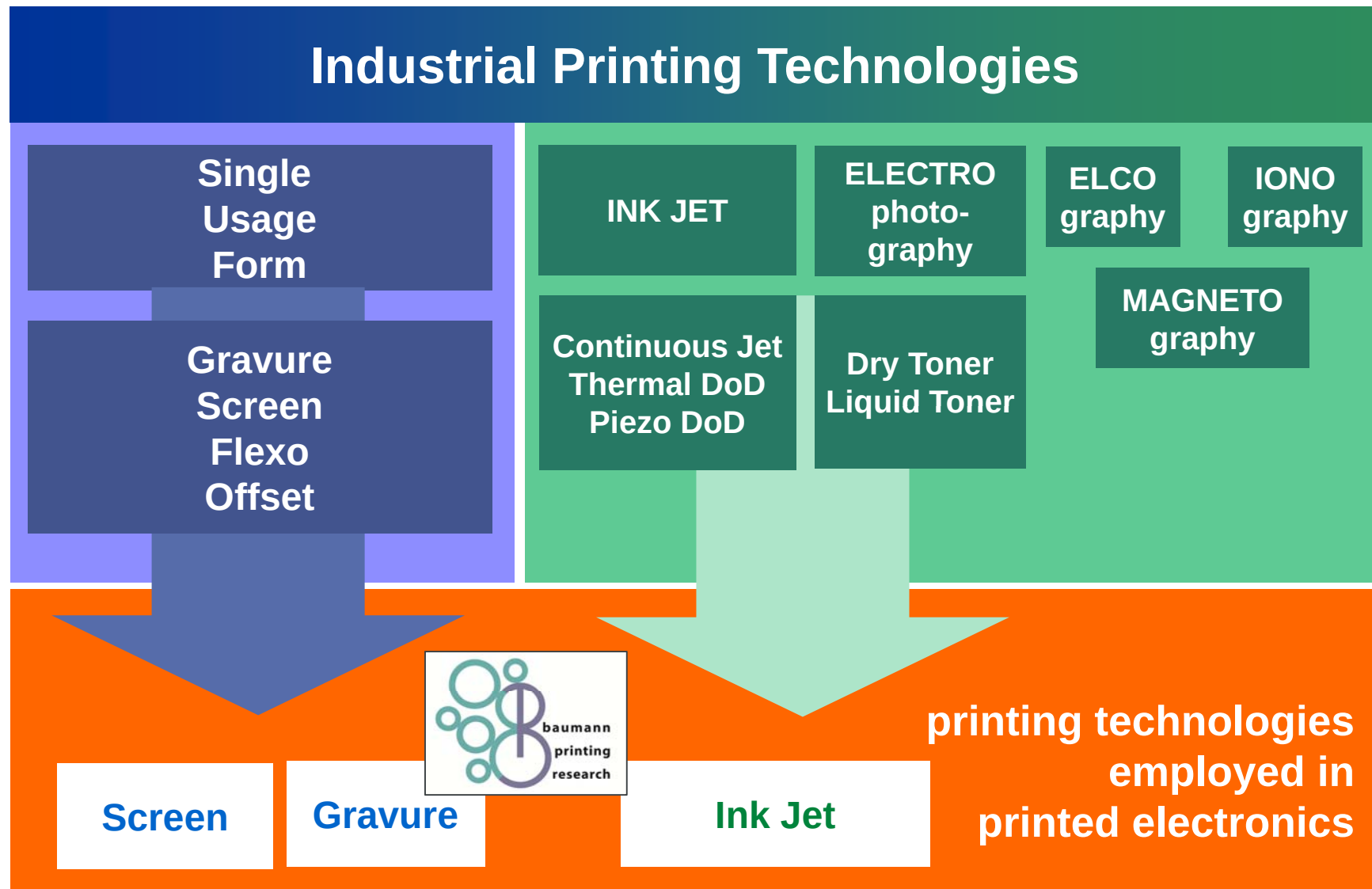
- in case of web fed, no batch handling
- easy flexible substrate handling, fiber or plastic based

Printing is regularly carried out under ambient conditions

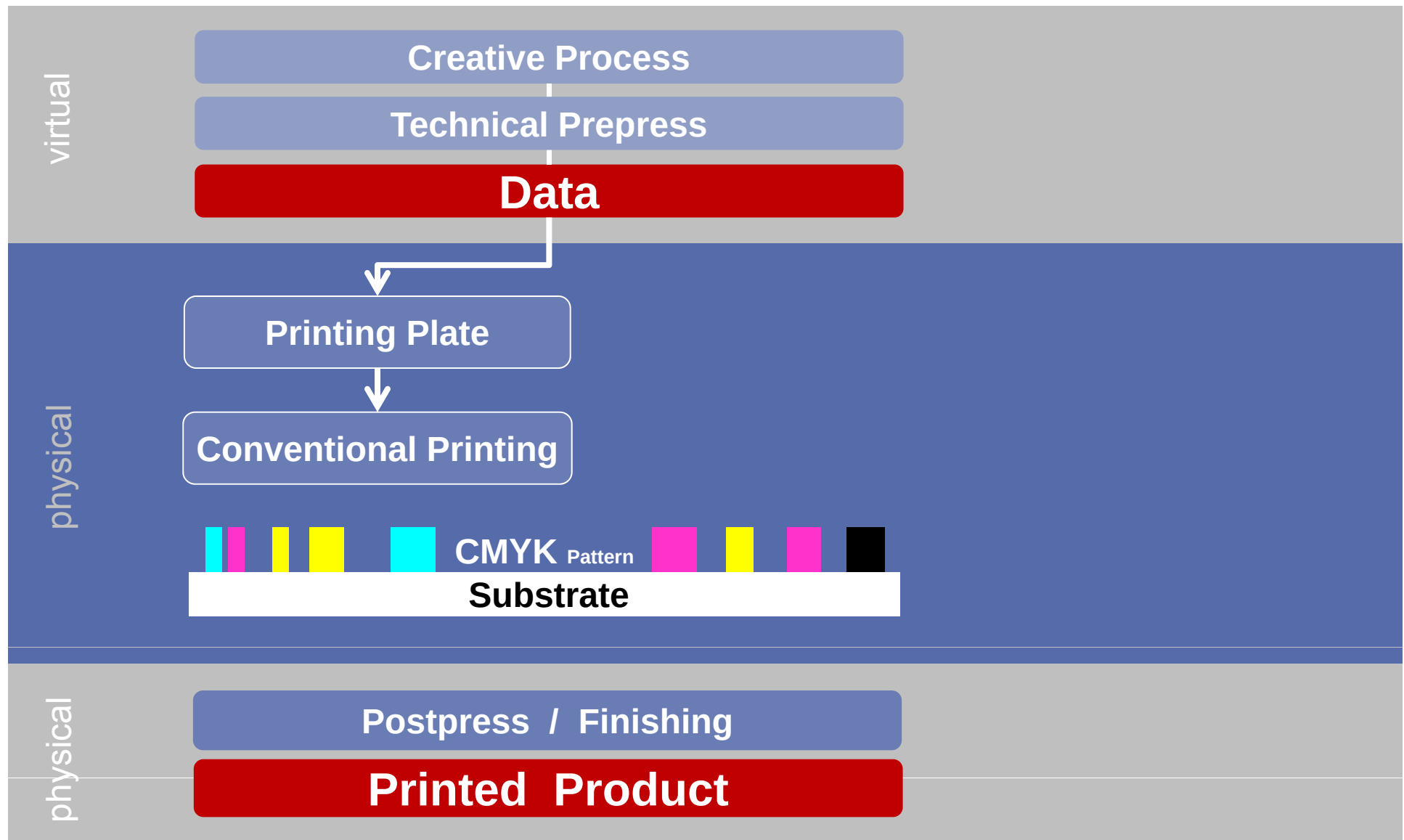
- no vacuum needed for material deposition
- clean and/or inert conditions are OK

Printing is a highly productive manufacturing technology

Additive Printing Technologies, most employed in **Large Area Electronics Fabrication**



Printing Process Chain



Typical Data of Web Fed Gravure Printing

Web width: 800 4.300 mm

Substrate Speed: up to 15 m/s (50 km/h)

Output: up to 200.000 m²/h

Substrates:

- paper
- carton
- aluminium
- polymer films

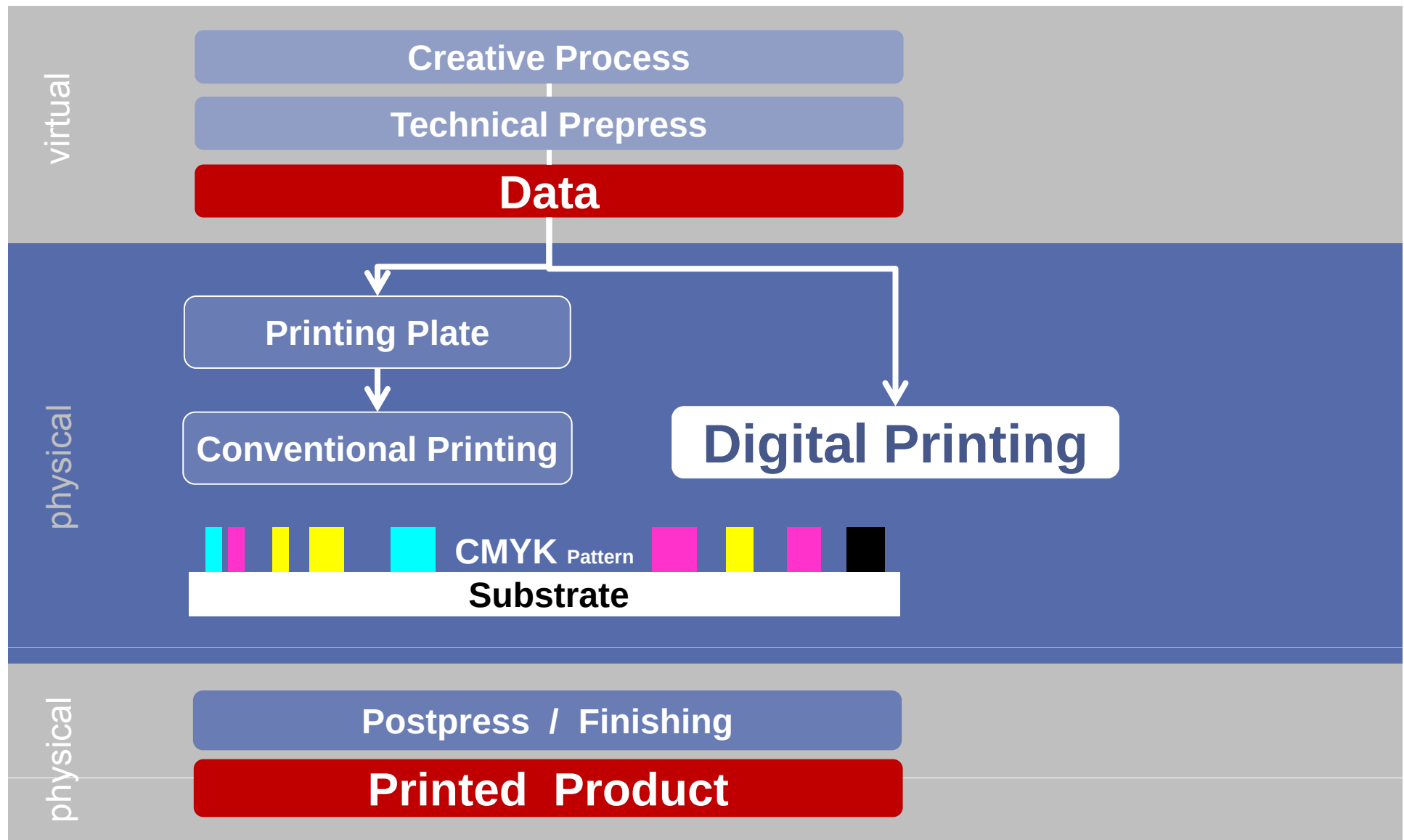
} typ. Thickness < 0,5 mm

Configuration:

- simplex or duplex printing
- free configuration of printing system on customer demands / specifications



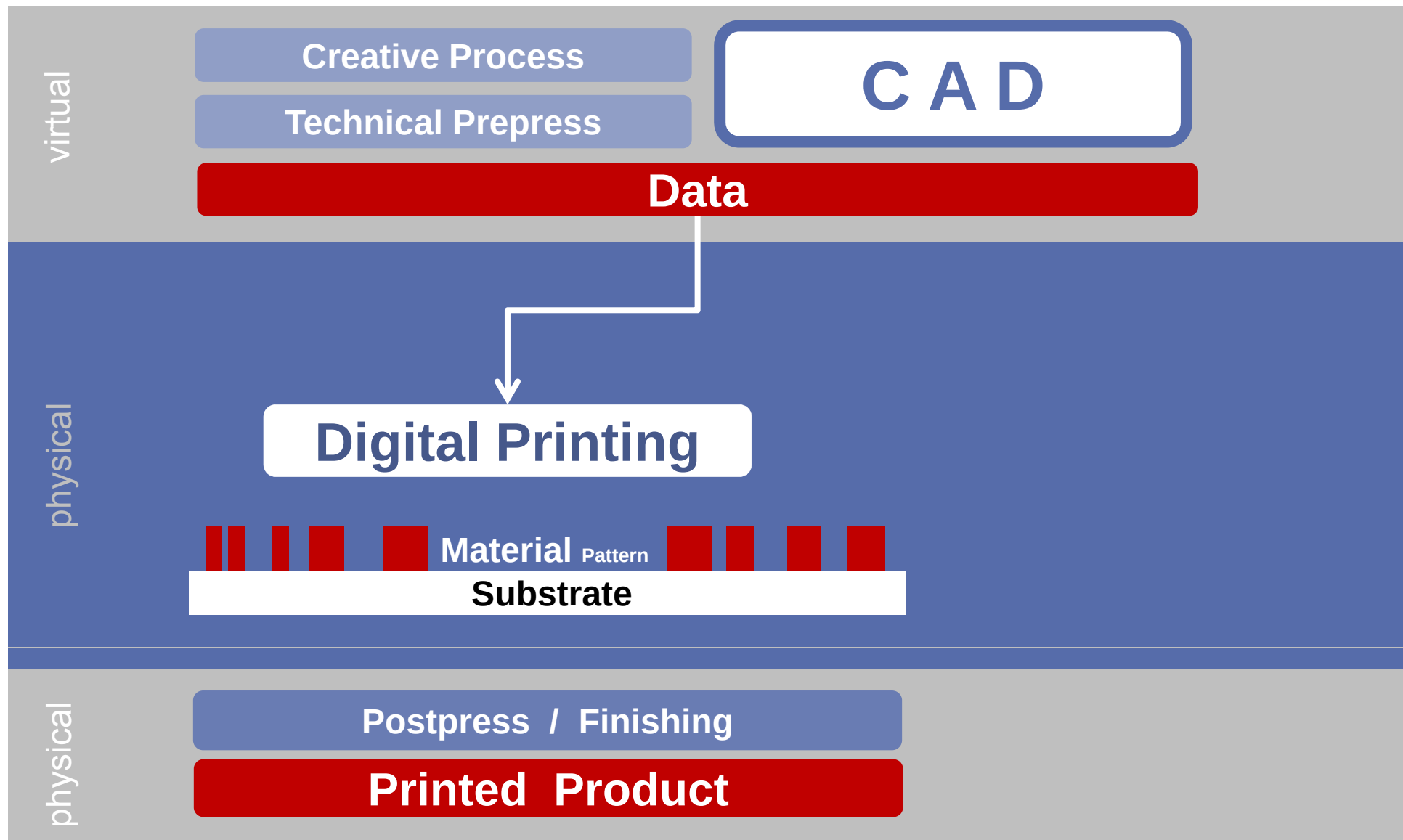
Printing Process Chain



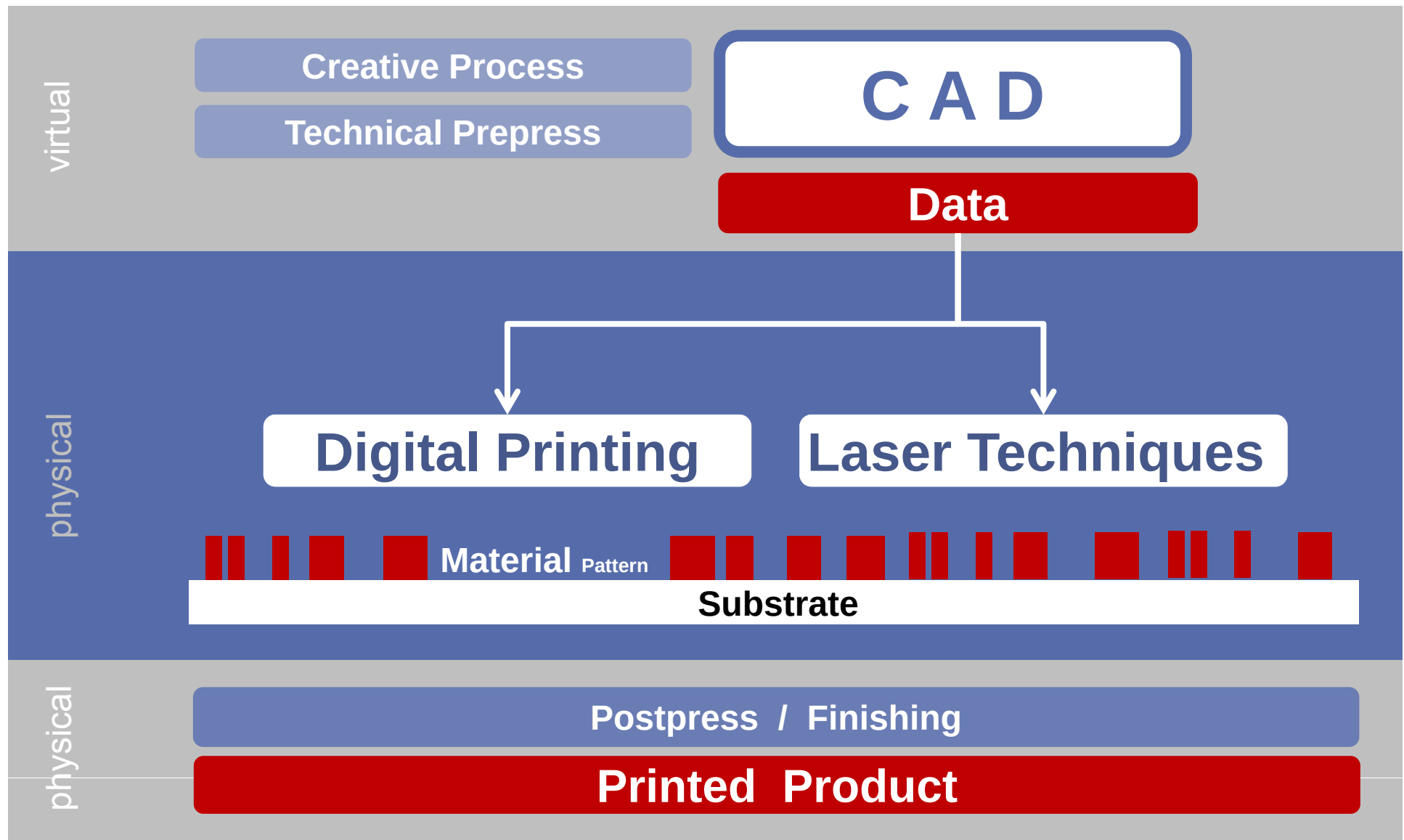
Industrial Inkjet Printing 2012 @ DRUPA



Printing Process Chain



Digital Fabrication Process Chain



Opportunities

Digital Fabrication → product run length **1**
→ change over time **0**

Typical DF Technologies → Digital Printing
→ Laser Processing
→ their chaining
→ chaining with analogue technologies

Printing Beyond

- The Manufacturing Technology Printing
- Functional Printing Machinery
- Applications: Printed Smart Objects

Printing Functionality Separations

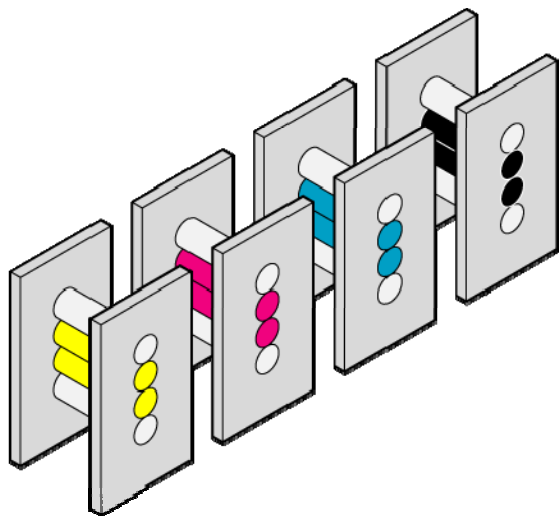
Functional Layers

Conductivity

Dielectric

Semi-conductivity

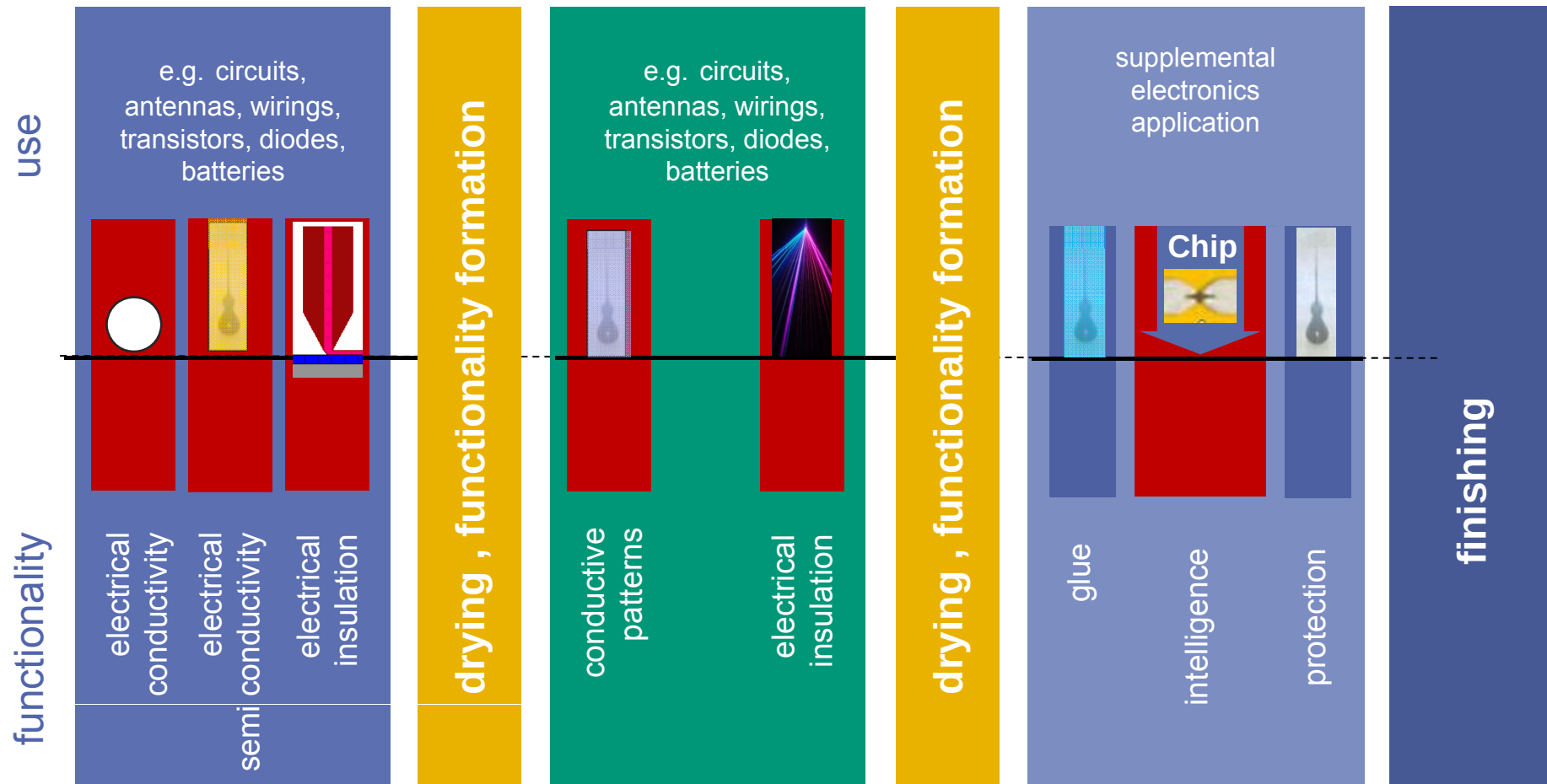
Conductivity



1 functionality separation
per
functional material:

„Information, at
which position
on the substrate
which **functional material**
has to be deposited“

Digital Hybrid Manufacturing Systems



printed functionalities by printing functionality separations



Autodrop
Microdrop

1
XYZ



DMP2831
Dimatix

16
XYZ



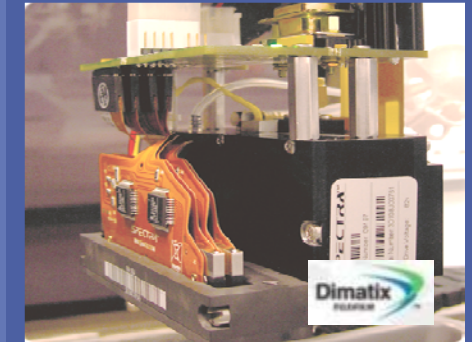
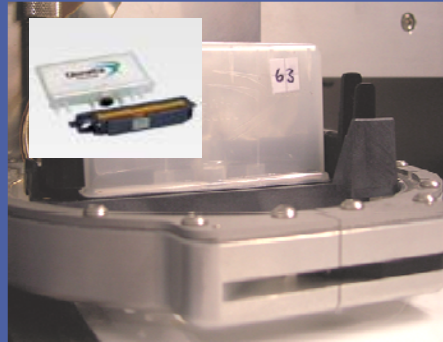
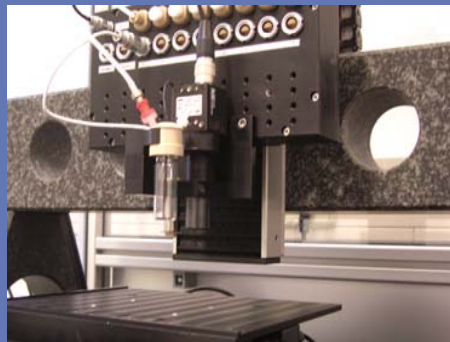
DMP3000
Dimatix

16 / 128
XYZ



INERT
Dimatix
XAAR

16 / 128
XYZ





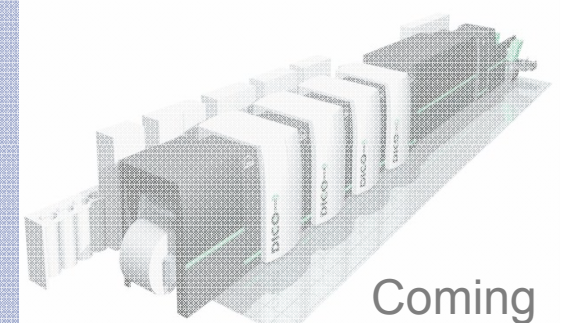
gravurMAN
(Xaar printheads)

1001
R2R



MicroFlex
(Dimatix SCANPAQ)

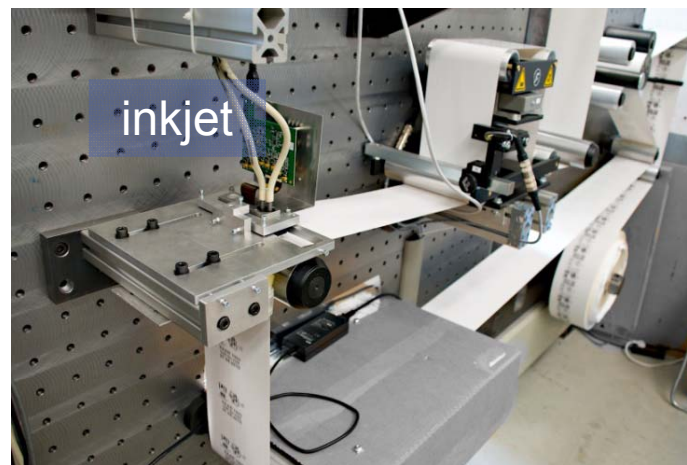
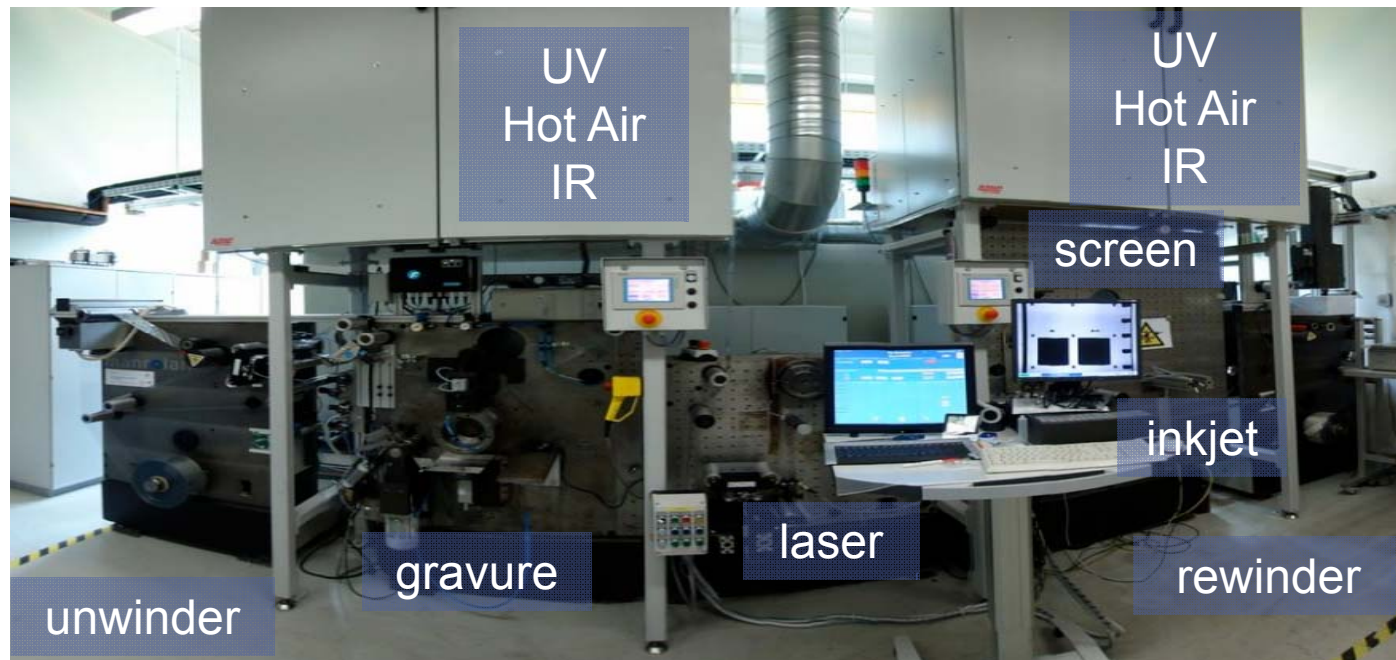
2 x 2 x 256
R2R



DICOweb
manroland

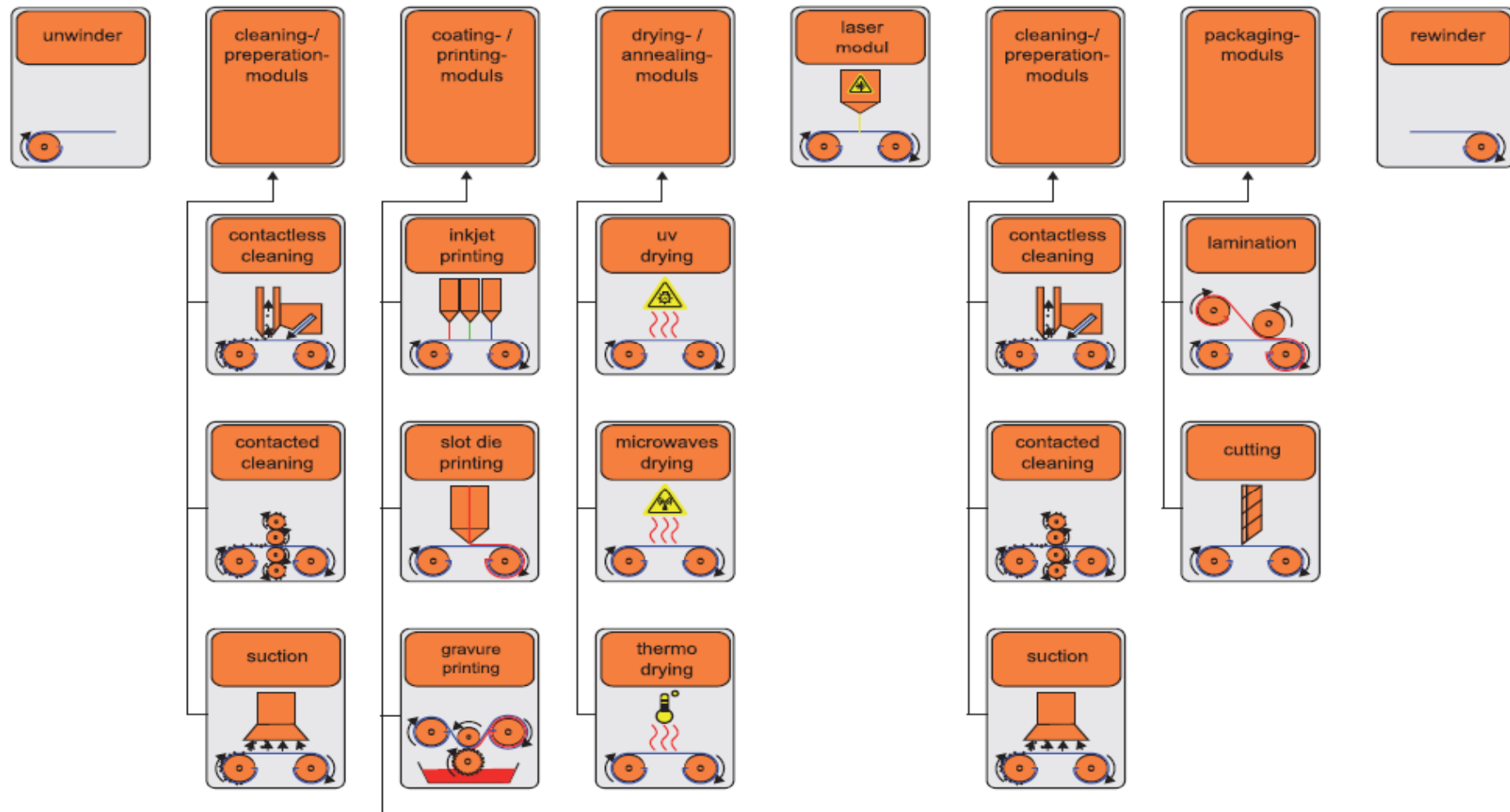
4 over 4 offset
Web fed

printing competence in Chemnitz gravureMAN → digital fabrication system



the modularity concept

adapt the manufacturing system to the product



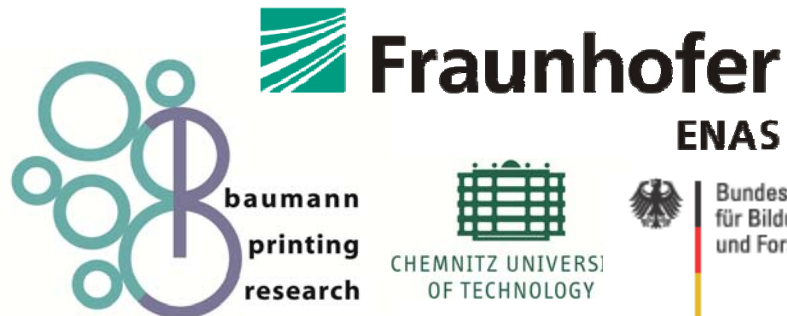
microFLEX: R2R Micro Manufacturing Machine



First Choice in microMachining

Machine Design & Setup

www.3d-micromac.com



Process & Applications

www.enas.fraunhofer.de/en/departments/PF
www.tu-chemnitz.de/mb/DigiTech



Santa Clara, CA, USA

Industrial Inkjet Technology

www.dimatix.com



Austin, TX, USA

Ink & Photonic Sintering

www.novacentrix.com

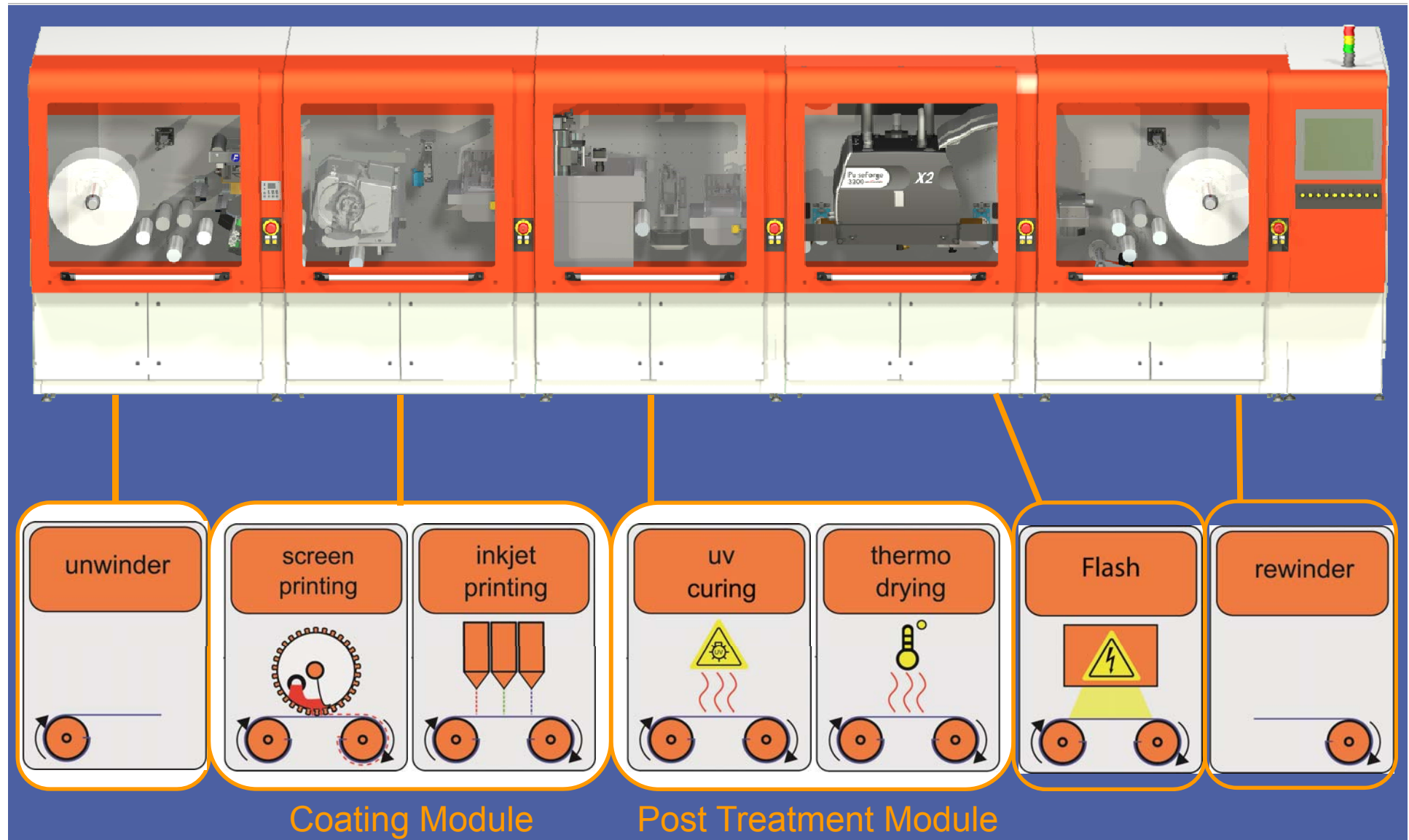
microFLEX™

the key features



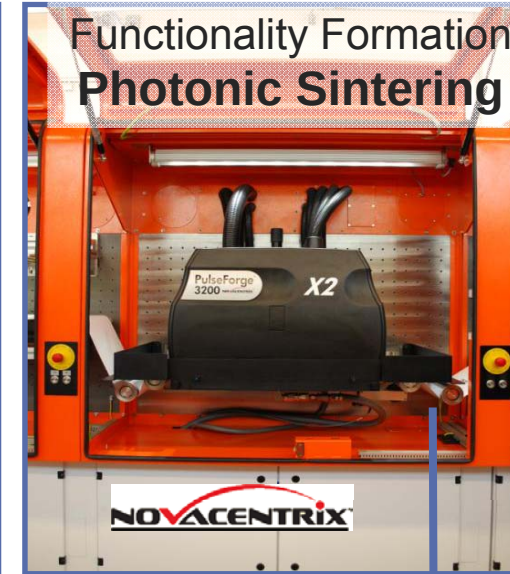
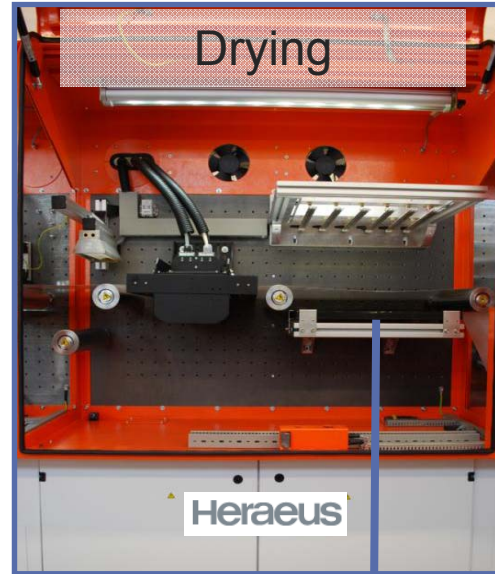
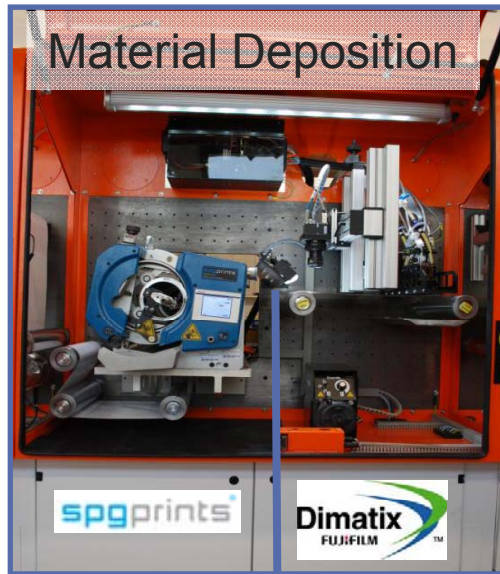
- R&D and Production
- Modular Setup
- Hybrid Technology
- R2R / R2S / R2P
- One Side Wall
- Controlled Atmosphere

microFLEX: the Copper Setup

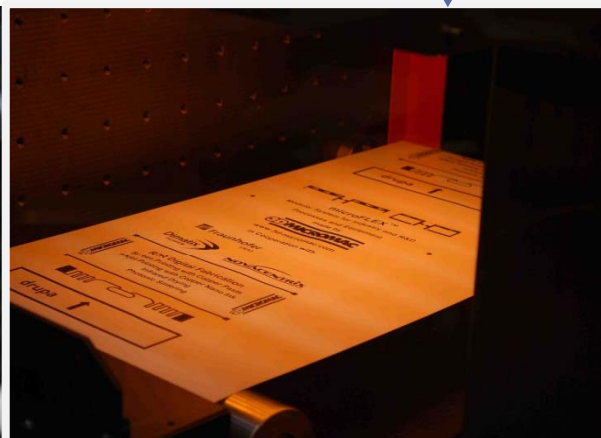


microFLEX

Our Setup & Process, May 2012



Screen/Inkjet Printing



IR Drying



Conductive Copper Pattern

microFLEX: Copper Setup → the **RESULT**



printing competence in Chemnitz **micro FLEX**
Micromachining for Industrial Applications and R&D



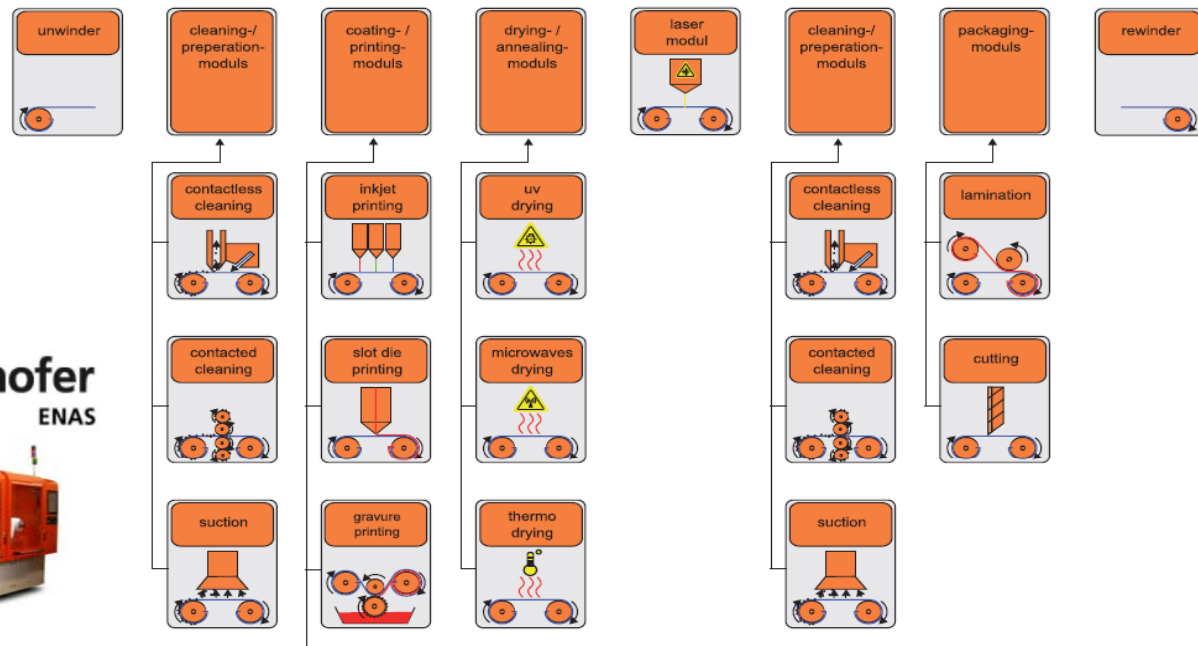
© 3D-Micromac AG 2012



CHEMNITZ UNIVERSITY
OF TECHNOLOGY



Fraunhofer
ENAS



printing competence in Chemnitz **micro FLEX**
Micromachining for Industry and R&D

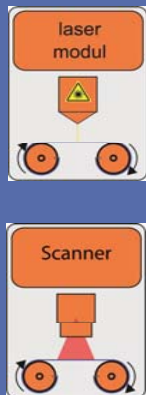


for Organic Photovoltaics

© 3D-Micromac AG 2012



Laser Patterning



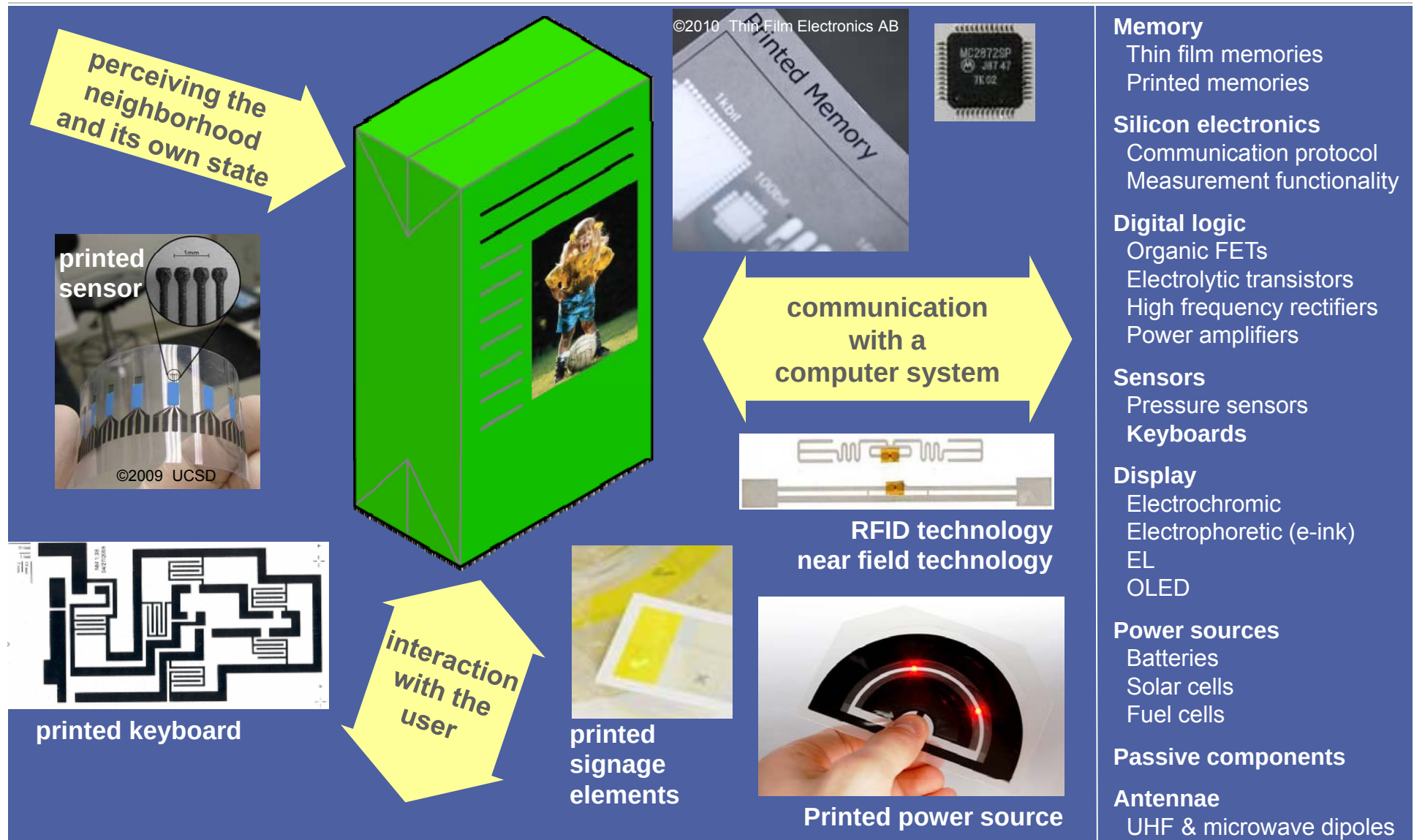
- Batch size >1
- Change over time 0
- PROTOTYPING, but

Ready for Digital Fabrication

Printing Beyond

- The Manufacturing Technology Printing
- Functional Printing Machinery
- Applications: Printed Smart Objects

The Vision : printed smart objects for the internet of things



Printing Functionalities Beyond Color

→ activities in Chemnitz so far



Color Cyan
Color Magenta
Color Yellow
Color Black

Process Colors

Gloss & Protection

Coating

Electric Power
Adapted Dielectric Properties
Electrical Conductivity
Electrical Semi-Conductivity
Electro-Luminescence / Light Emission

Circuitry

Sensing Environment

Sensors

Surface Modification
Surface Protection
Catalysis
Porosity (filter, membranes)

Process Support

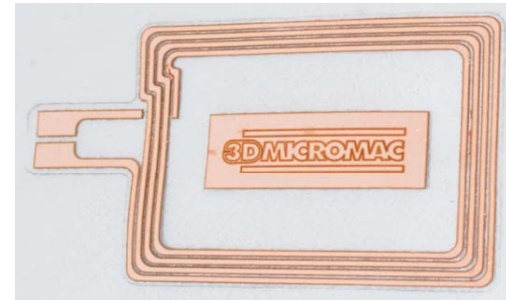
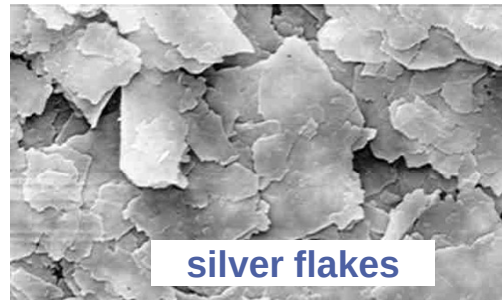
Intelligence via Si-Chip and / or Supplemental Electronics
Geometric Shape / Laser Patterning / Cutting

Hybrid Tech

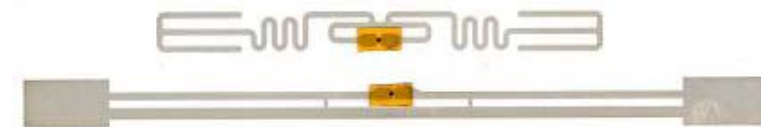
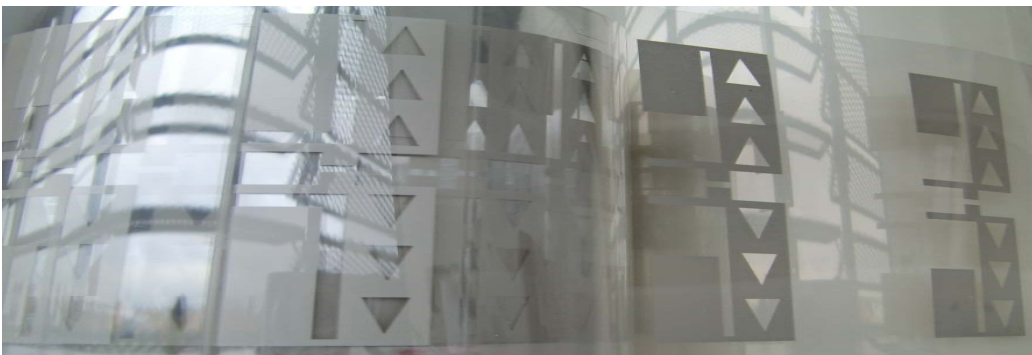
Conducting Inks Made From Particles

RFID antennas and Keyboards

applying Silver and Carbon flakes filled Inks

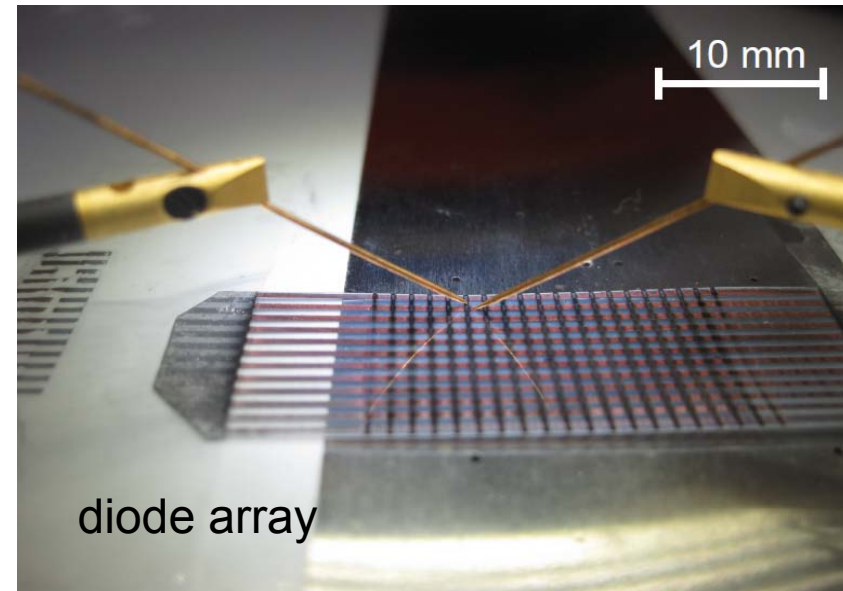
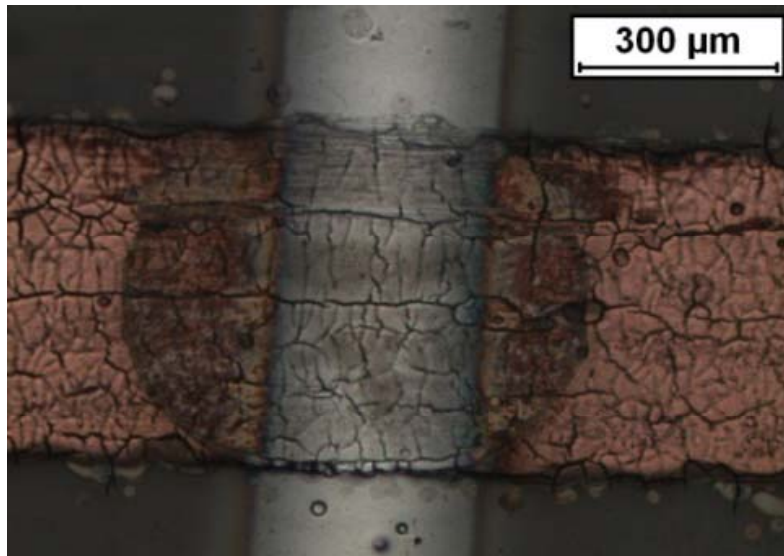


printed on web fed
LABORMAN &
MICROFLEX®



Inkjet printed Schottky Diode on PET photonic sintering @ room temperature

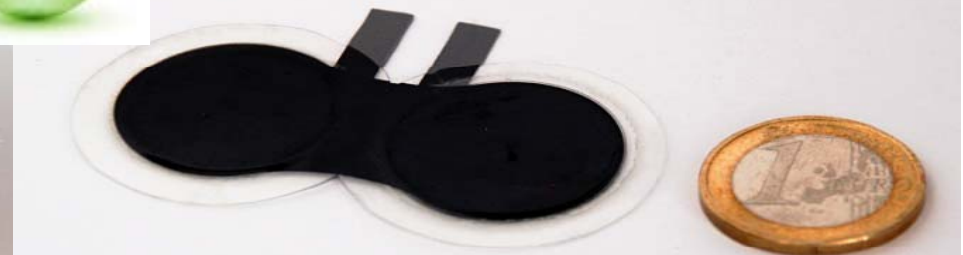
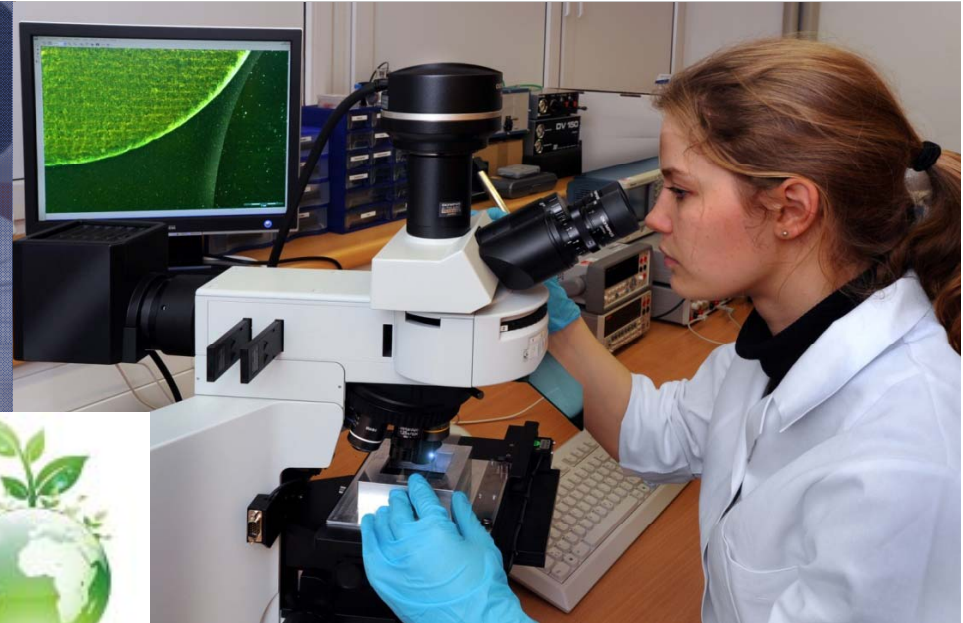
Al	~ 200 nm sputtered
CdS	~ 50 nm Inkjet printed
Cu	~ 500 nm Inkjet printed
PET	



N. Marjanovic *et al.*
J. Mater. Chem., 2011, 21, 13634

Printing Flexible Batteries (Zn/MnO_2)

- single cell of 1.5 V nominal voltage
- discharge current: 200 μA (constant)
- cut-off voltage: 0.9 V
- capacity: $> 5 \text{ mAh/cm}^2$ (adoptable)
- thickness: $< 1 \text{ mm}$
- weight: approx. 0.8 g



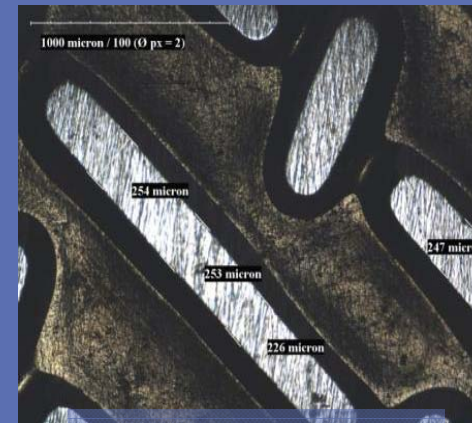
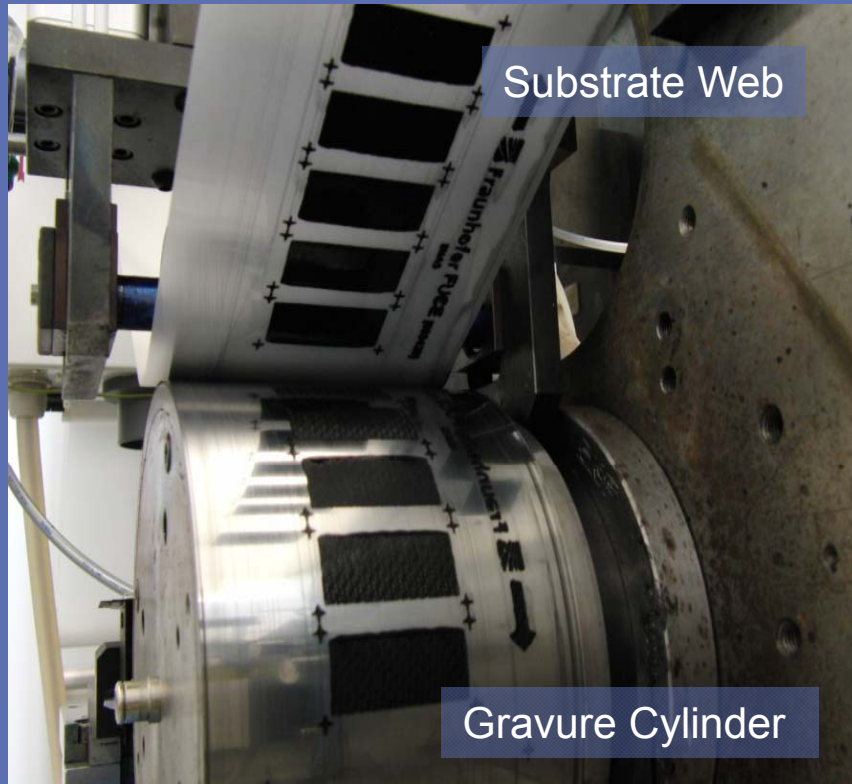
1,5 V ... 6 V capacity $> 5 \text{ mAh/cm}^2$

All Printed Flexible Batteries Xmas 2011

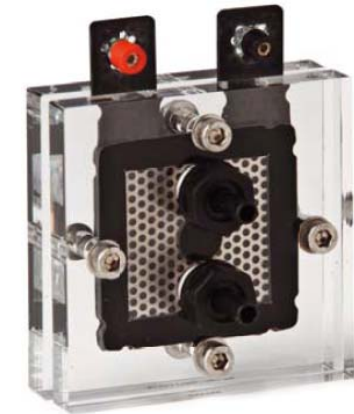
1000 integrated batteries shipped → integration in printed products



Gravure Printed Fuel Cell Membranes



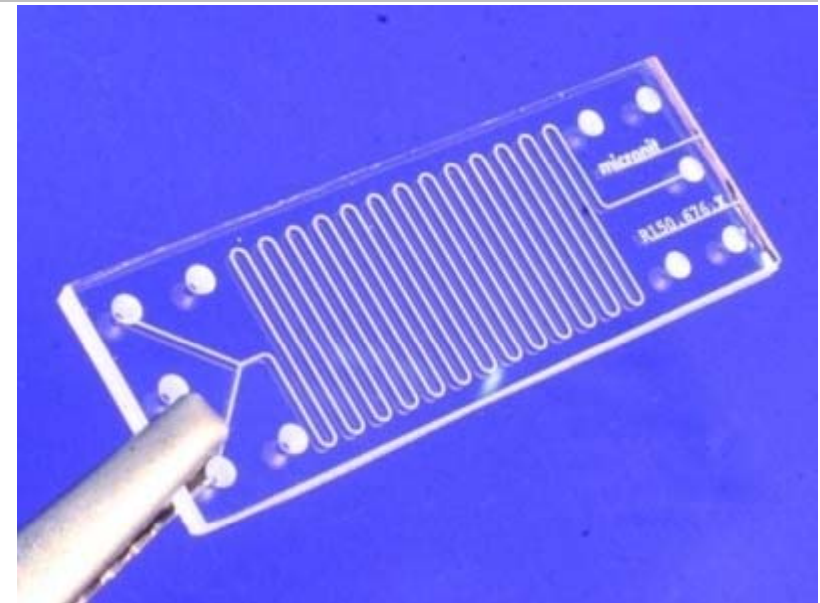
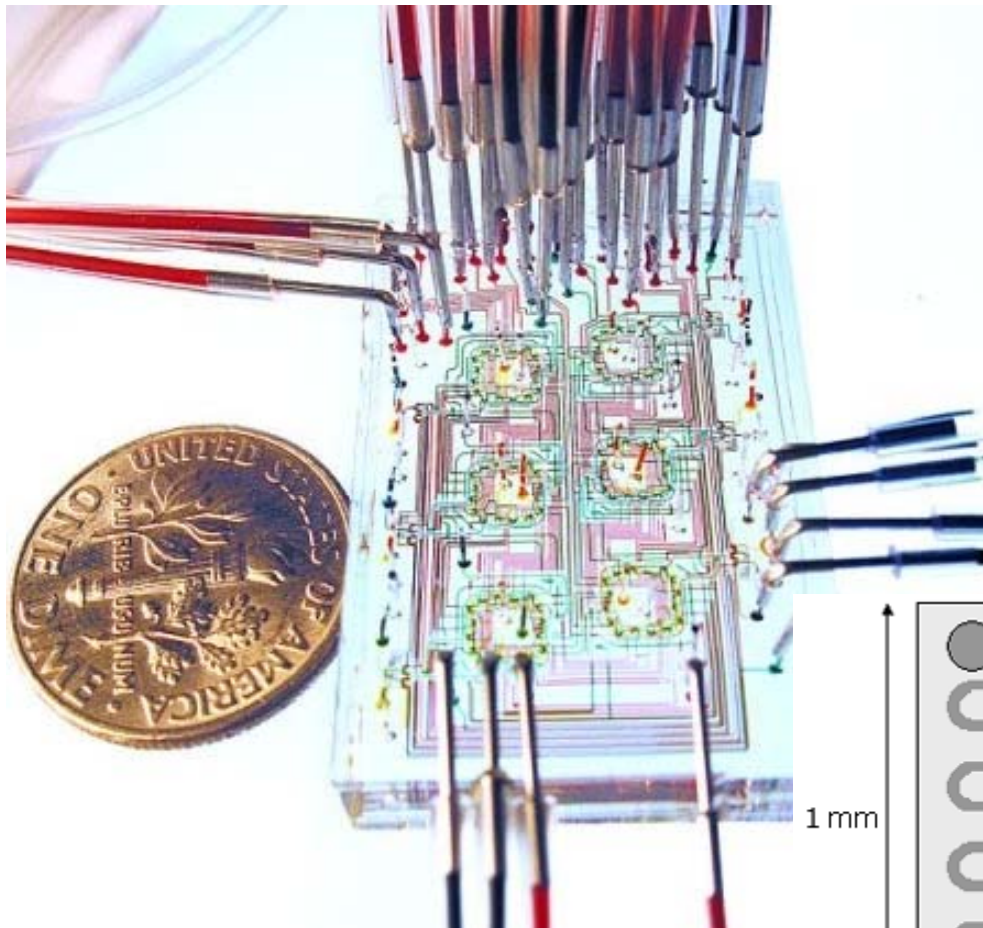
Gravure Cells



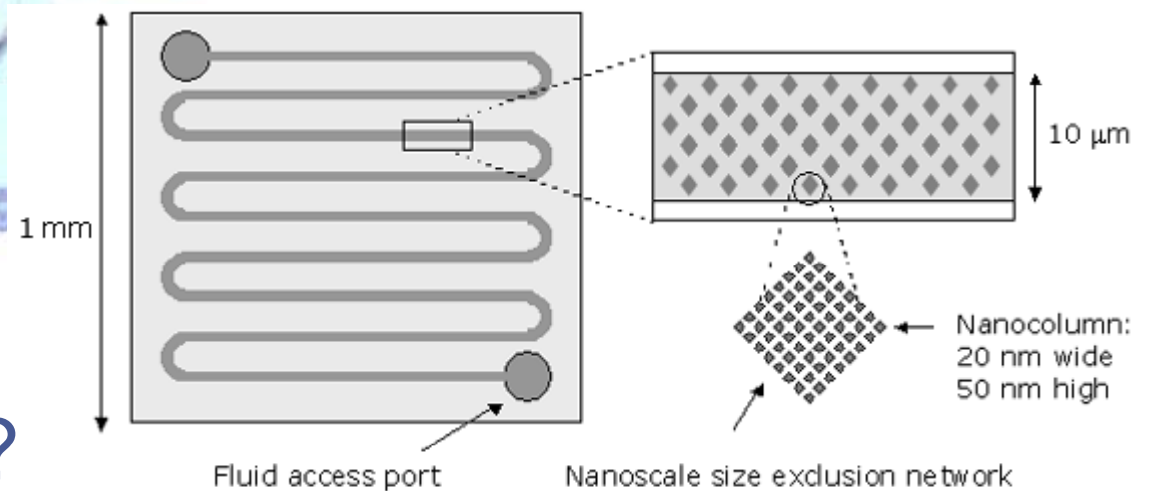
F. Siegel et al.: Gravure Printing of Thick Film Electrodes for PEM Fuel Cell Production . Proc. iargai, Budapest 2011

Lab-on-Chip → analysis of body fluids

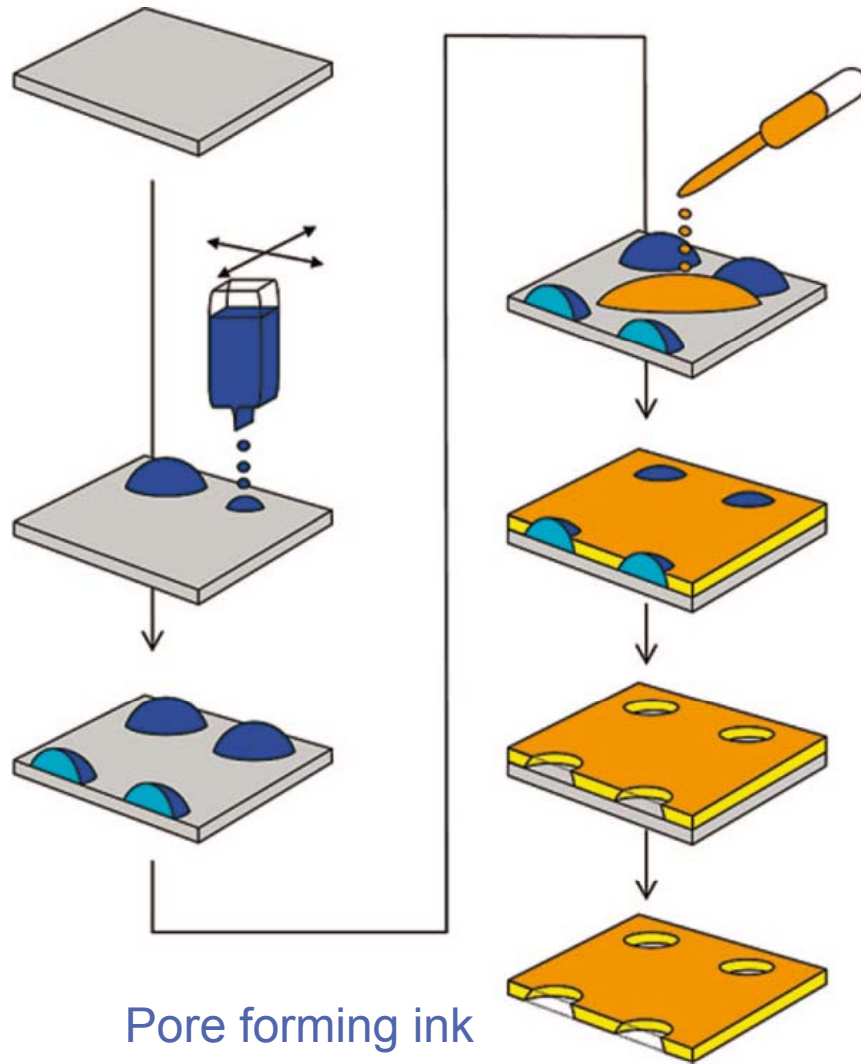
source of figures: http://gmwgroup.harvard.edu/research_microfluidics.html



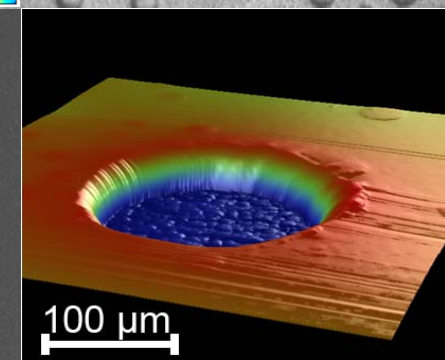
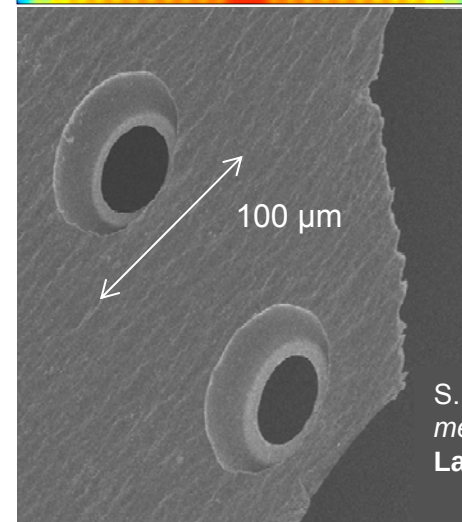
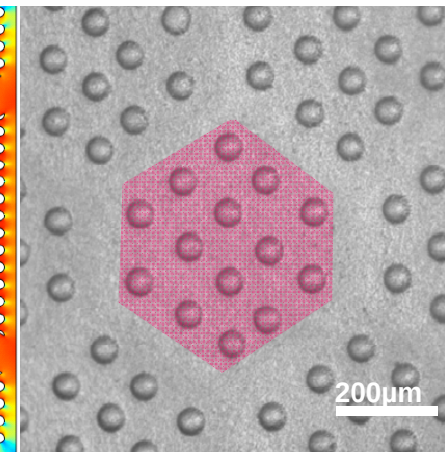
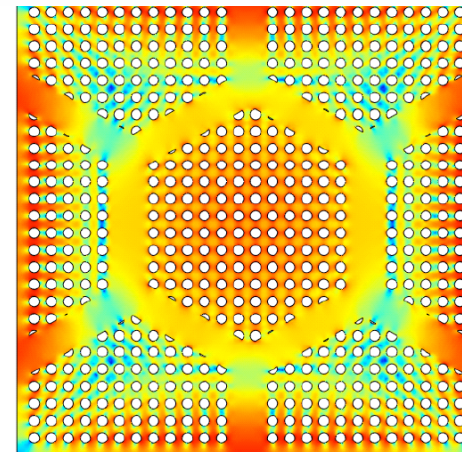
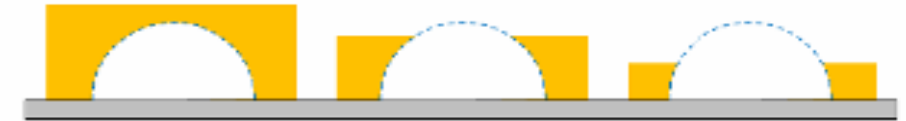
μ and nano filter ?



Printed Polymeric Microsieves



Pore forming ink
Polymer solution

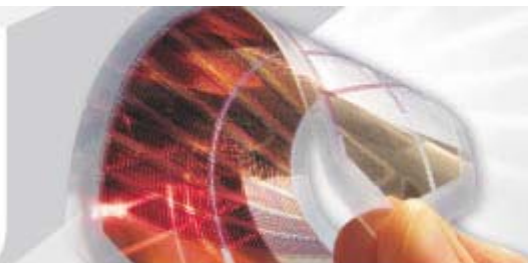


S. F. Jahn et al.: *Inkjet fabrication method for polymer microsieves*. *Langmuir*, 2009, 25 (1), 606–610.

German Patent DE102006016063.0

Printing Beyond

Where to meet the
Functional Printers ?



Call for Papers

We encourage all scientists and engineers active in large-area, organic and printed electronics to present a scientific paper at LOPE-C 2013!

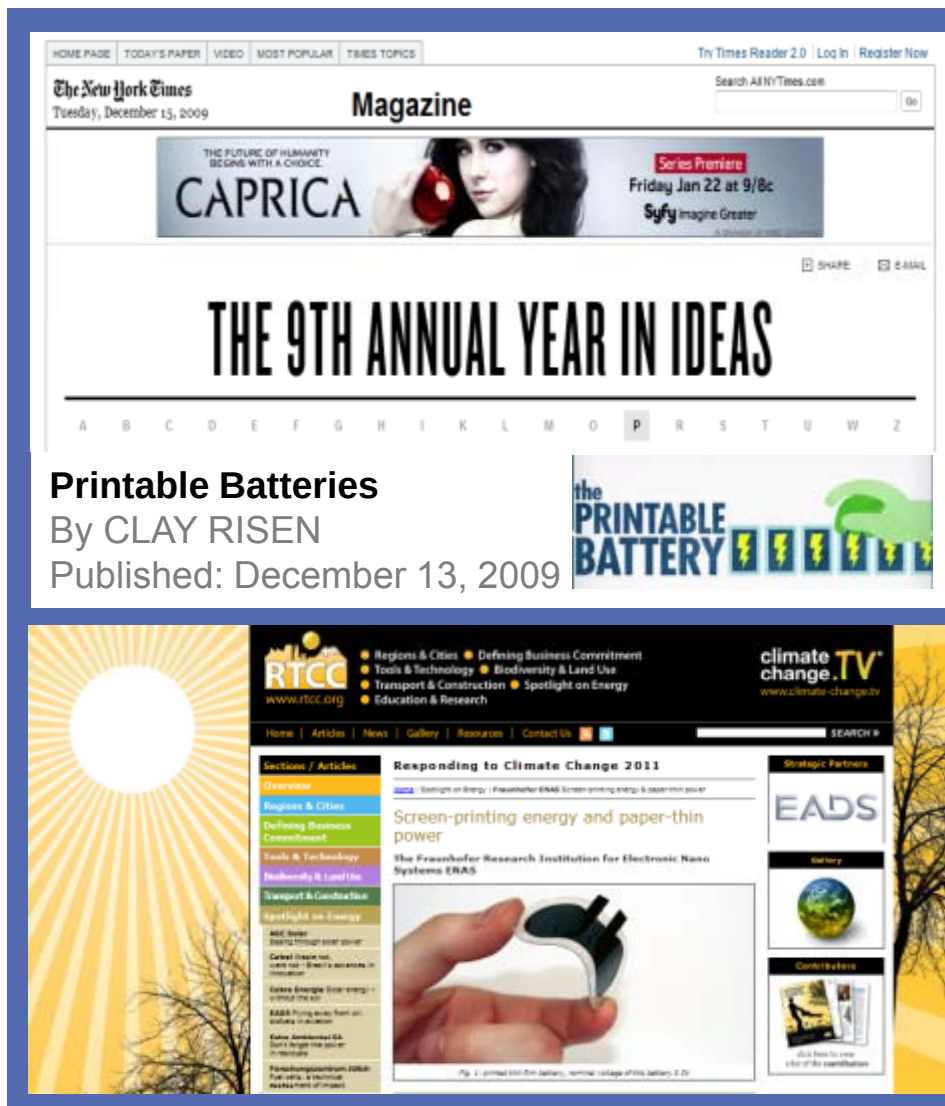
LOPE-C is the premier annual international conference and exhibition...
...of organic and printed electronics. It is hosted by the OE-A (Organic and Printed Electronics Association) and organized by Messe München GmbH.

LOPE-C covers the entire industrial value chain:
academic research, industrial R&D, manufacturing, roadmapping,
standardization and end-user considerations.

**Due date for abstract submission
is January 18 2013**



Thank you for your attention ...



... always welcome in Chemnitz, Saxony!



Prof. Dr. Reinhard R. Baumann
reinhard.baumann@enas.fraunhofer.de